

Transient Voltage Suppressors for ESD Protection

FEATURES:

- ┆ Small Body Outline Dimensions:
0.039 x 0.024 (1.0 mm x 0.60 mm)
- ┆ Low Body Height: 0.017 (0.43 mm) Max
- ┆ Stand-off Voltage: 3.3 V – 12 V
- ┆ Low Leakage
- ┆ Response Time is Typically < 1 ns
- ┆ ESD Rating of Class 3 (> 16 kV) per Human Body Model
- ┆ IEC61000-4-2 Level 4 ESD Protection
- ┆ We declare that the material of product compliance with RoHS requirements.

Circuit Diagram & Pin Configuration:



SOD-923



PIN 1. CATHODE
2. ANODE

DEVICE MARKING AND ORDERING INFORMATION

Device	Marking	Shipping
TESDN121AD92	H	8000/Tape&Reel

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
IEC 61000-4-2 (ESD) Air Contact Contact discharge		±15 ±8	kV kV
ESD Voltage Per Human Body Model		16	kV
Total Power Dissipation on FR-5 Board (Note 1) @ T _A =25	PD	150	Mw
Junction and Storage Temperature Range	T _J , T _{STG}	-55 to 150	
Lead Solder Temperature – Maximum (10 Second Duration)	TL	260	

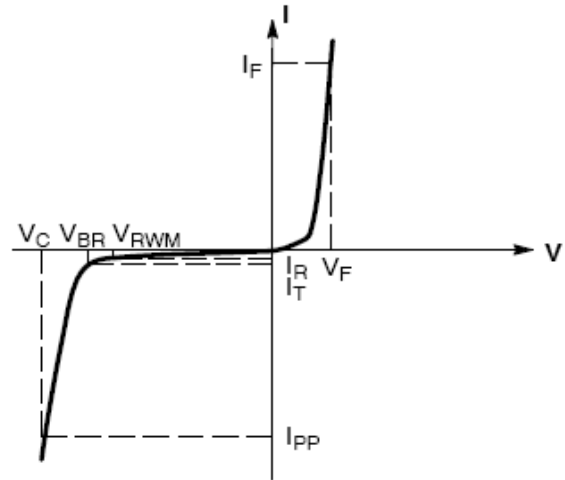
Stresses exceeding Maximum Ratings may damage the device. Maximum Rating are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. FR-5 = 1.0*0.75*0.62 in.

ELECTRICAL CHARACTERISTICS

($T_A = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter
I_{PP}	Maximum Reverse Peak Pulse Current
V_C	Clamping Voltage @ I_{PP}
V_{RWM}	Working Peak Reverse Voltage
I_R	Maximum Reverse Leakage Current @ V_{RWM}
V_{BR}	Breakdown Voltage @ I_T
I_T	Test Current
I_F	Forward Current
V_F	Forward Voltage @ I_F
P_{pk}	Peak Power Dissipation
C	Max. Capacitance @ $V_R = 0$ and $f = 1 \text{ MHz}$



Uni-Directional TVS

ELECTRICAL CHARACTERISTICS ($T_A=25$ unless otherwise noted, $V_F=0.9\text{V}$ Max. @ $I_F=10\text{Ma}$ for all types)

Device	V_{RWM} (V)	I_R (μA) @ V_{RWM}	V_{BR} (V) @ I_T (Note 2)	I_T (mA)	I_{PP} (A) (Note 3)	V_C (V) @ Max I_{PP} (Note 3)	P_{PK} (W) (8*20 μs)	C (pF)
	Max	Max	Min		Max	Max	Typ	Typ
TESDN121AD92	12	1.0	13.5	1.0	5.9	23.7	140	30

Other voltage available upon request.

2. V_{BR} is measured with a pulse test current I_T at an ambient temperature of 25

3. Surge current waveform per Figure 3.

TYPICAL CHARACTERISTICS

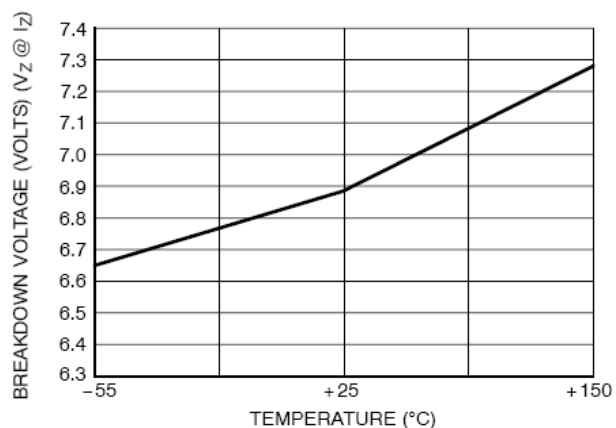


Figure 1. Typical Breakdown Voltage versus Temperature

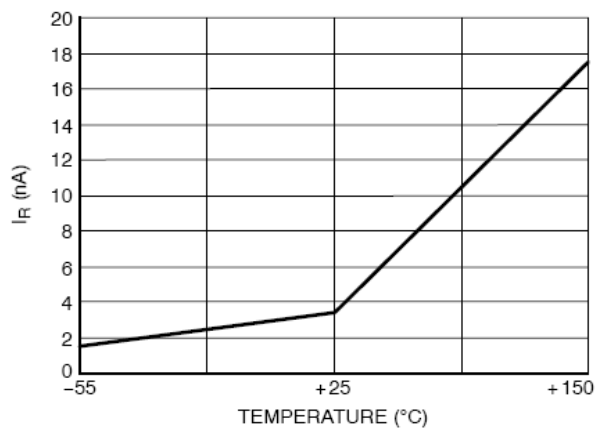


Fig 2. Typical Leakage Current versus Temperature

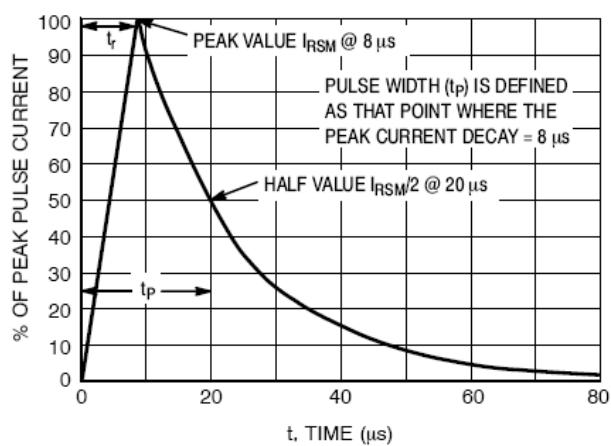
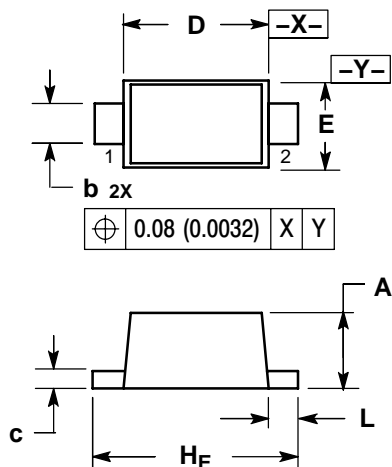


Figure 3. 8*20 μ s Pulse Waveform

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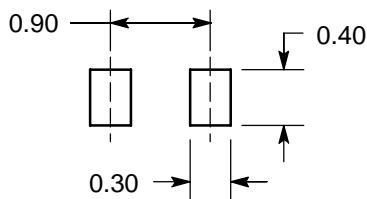


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.

DIM	MILLIMETERS			INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.34	0.37	0.40	0.013	0.015	0.016
b	0.15	0.20	0.25	0.006	0.008	0.010
c	0.07	0.12	0.17	0.003	0.005	0.007
D	0.75	0.80	0.85	0.030	0.031	0.033
E	0.55	0.60	0.65	0.022	0.024	0.026
HE	0.95	1.00	1.05	0.037	0.039	0.041
L	0.05	0.10	0.15	0.002	0.004	0.006

SOLDERING FOOTPRINT*



DIMENSIONS: MILLIMETERS

NOTICE

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